



MMBD4448HT /HTA /HTC /HTS

SURFACE MOUNT FAST SWITCHING DIODE

Features

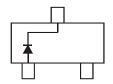
- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Notes 2 and 3)

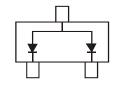
Mechanical Data

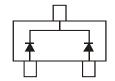
- Case: SOT-523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- · Polarity: See Diagrams Below
- Weight: 0.002 grams (approximate)

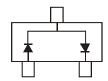
SOT-523











TOP VIEW

MMBD4448HT Marking: A3

MMBD4448HTA Marking: A6

MMBD4448HTC Marking: A7

MMBD4448HTS Marking: AB

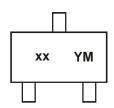
Ordering Information (Note 4)

Part Number	Case	Packaging
MMBD4448HT-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTA-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTC-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTS-7-F	SOT-523	3000/Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



xx = Product Type Marking Code (See Page 1 Diagrams)

YM = Date Code Marking Y = Year (ex: N = 2002)

M = Month (ex: 9 = September)

Date Code Key

Date Code	ney														
Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	М	Ν	Р	R	S	T	U	٧	W	Х	Υ	Z	Α	В	С
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D



Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current (Note 5)		I _{FM}	500	mA
Average Rectified Output Current (Note 5)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	150	mW
Thermal Resistance Junction to Ambient (Note 5)	$R_{ heta JA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition									
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	80		٧	$I_R = 2.5 \mu A$									
		0.62	0.72		$I_F = 5.0 \text{mA}$									
Forward Voltage	\/-	_	0.855	V	$I_F = 10 \text{mA}$									
Forward Voltage	V _F	_	1.0		$I_F = 100 \text{mA}$									
		_	1.25		I _F = 150mA									
	I _R		100	nA	$V_R = 70V$									
Leakage Current (Note 6)		I _R	I _R		50	μΑ	$V_R = 75V, T_J = 150^{\circ}C$							
Leakage Current (Note 6)				IR.	IR.	'R	чR	IR.	IR.	'R	IR.	'R	IR.	
			25	nA	$V_R = 20V$									
Total Capacitance	C _T		3.5	pF	$V_R = 6V, f = 1.0MHz$									
Reverse Recovery Time	t _{rr}	_	4.0	ns	$V_R = 6V$, $I_F = 5mA$									

Notes: 5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.



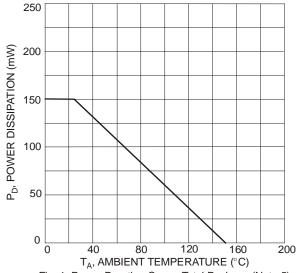


Fig. 1 Power Derating Curve, Total Package (Note 5)

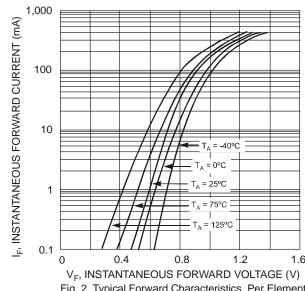
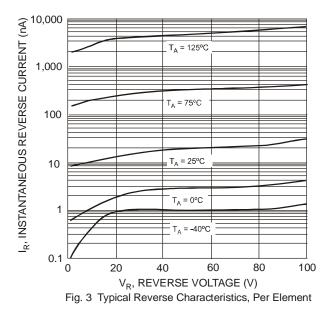


Fig. 2 Typical Forward Characteristics, Per Element





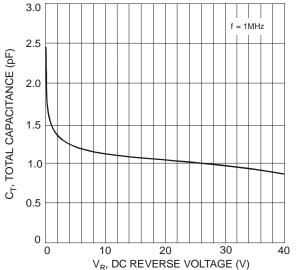
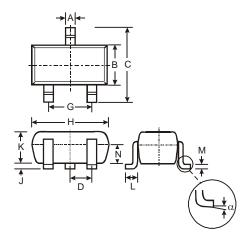


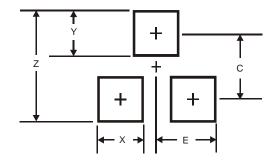
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions



SOT-523							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.22				
В	0.75	0.85	0.80				
С	1.45	1.75	1.60				
D			0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
J	0.00	0.10	0.05				
K	0.60	0.80	0.75				
L	0.10	0.30	0.22				
М	0.10	0.20	0.12				
N	0.45	0.65	0.50				
α	0°	8°	_				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
E	0.7



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